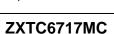




A Product Line of Diodes Incorporated



### **COMPLEMENTARY 15V NPN & 12V PNP LOW SATURATION TRANSISTOR**

#### Features

#### NPN Transistor

- BV<sub>CEO</sub> > 15V
  - I<sub>C</sub> = 4.5A Continuous Collector Current
  - Low Saturation Voltage (100mV max @ 1A)
  - $R_{SAT} = 45m\Omega$  for a low equivalent On-Resistance

**PNP** Transistor

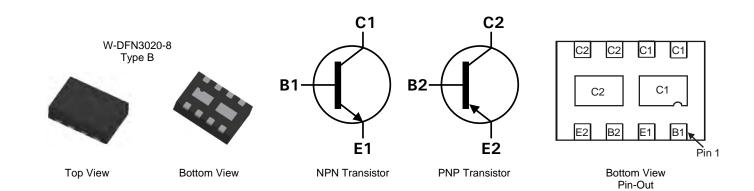
- BV<sub>CEO</sub> > -12V
- I<sub>C</sub> = -4A Continuous Collector Current
- Low Saturation Voltage (-140mV max @ -1A)
- $R_{SAT} = 60m\Omega$  for a low equivalent On-Resistance
- here characterized up to 12A for high current gain hold up
- Low profile 0.8mm high package for thin applications
- R<sub>0JA</sub> efficient, 40% lower than SOT26
- 6mm<sup>2</sup> footprint, 50% smaller than TSOP6 and SOT26
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP capable (Note 4)

### Mechanical Data

- Case: W-DFN3020-8 Type B
- Nominal package height: 0.8mm
- Case material: molded plastic. "Green" molding compound.
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu, Solderable per MIL-STD-202, Method 208 @
- Weight: 0.013 grams (approximate)

### Applications

- DC DC Converters
- Charging circuits
- Power switches
- Motor control
- LED Backlighting circuits
- Portable applications



### Ordering Information (Note 4 & 5)

Product	Compliance	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXTC6717MCTA	AEC-Q101	DA1	7	8	3,000
ZXTC6717MCQTA	Automotive	DA1	7	8	3,000

Notes:

1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.</li>

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified.

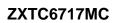
5. For packaging details, go to our website at http://www.diodes.com

### Marking Information



DA1 = Product type Marking Code Dot denotes Pin 1





# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	NPN	PNP	Unit	
Collector-Base Voltage		V <sub>CBO</sub>	40	-20	V	
Collector-Emitter Voltage		VCEO	15	-12	V	
Emitter-Base Voltage		V <sub>EBO</sub>	7	-7	V	
Peak Pulse Current		I <sub>CM</sub>	15	-12	A	
Continuous Collector Current	(Notes 6 & 9)	- I <sub>C</sub>	4.5	-4		
Continuous Collector Current	(Notes 7 & 9)		5	-4.45	A	
Base Current		IB	1		A	

### Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	NPN	PNP	Unit	
	(Notes 6 & 9)		1.5 12 2.45 19.6 1.13 8 1.7 13.6		₩ mW/°C
Power Dissipation	(Notes 7 & 9)	E.			
Linear Derating Factor	(Notes 8 & 9)	PD			
	(Notes 8 & 10)				
	(Notes 6 & 9)		83.3 51.0		-
Thermal Desistance, hunsting to Archiegt	(Notes 7 & 9)	-			
Thermal Resistance, Junction to Ambient	(Notes 8 & 9)	$R_{ extsf{ heta}JA}$	1	11	°C/W
	(Notes 8 & 10)		73.5		
nermal Resistance, Junction to Lead (Notes 9 & 11)		$R_{\theta JL}$	17.1		
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to	+150	°C	

6. For a dual device surface mounted on 28mm x 28mm (8cm<sup>2</sup>) FR4 PCB with high coverage of single sided 2 oz copper, in still air conditions; the device is Notes: measured when operating in a steady-state condition. The heatsink is split in half with the exposed collector pads connected to each half.

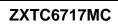
7. Same as note (6), except the device is measured at t <5 sec.</li>
8. Same as note (6), except the device is surface mounted on 31mm x 31mm (10cm<sup>2</sup>) FR4 PCB with high coverage of single sided 1oz copper.

9. For a dual device with one active die.

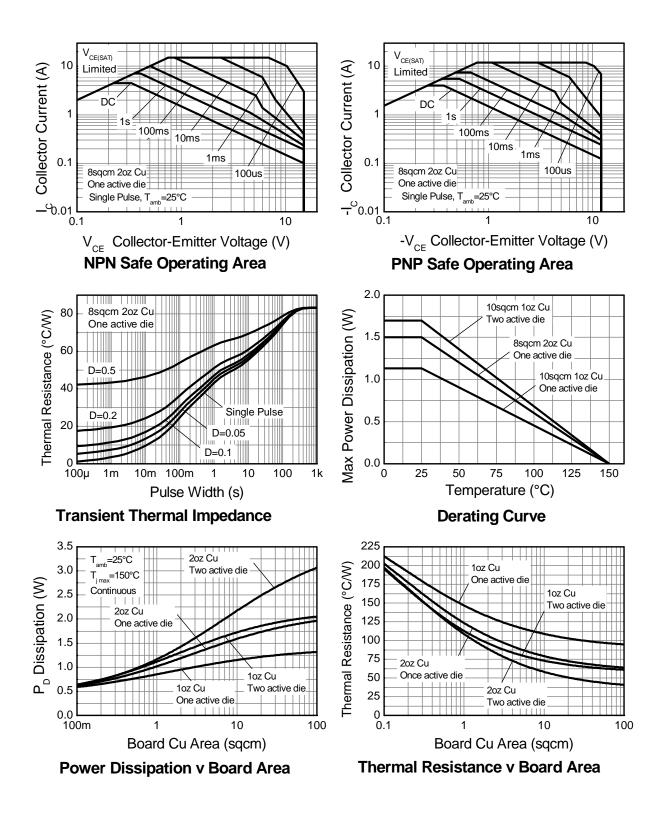
10. For dual device with 2 active die running at equal power.

11. Thermal resistance from junction to solder-point (on the exposed collector pads).

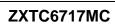




## Thermal Characteristics and Derating Information







### NPN - Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

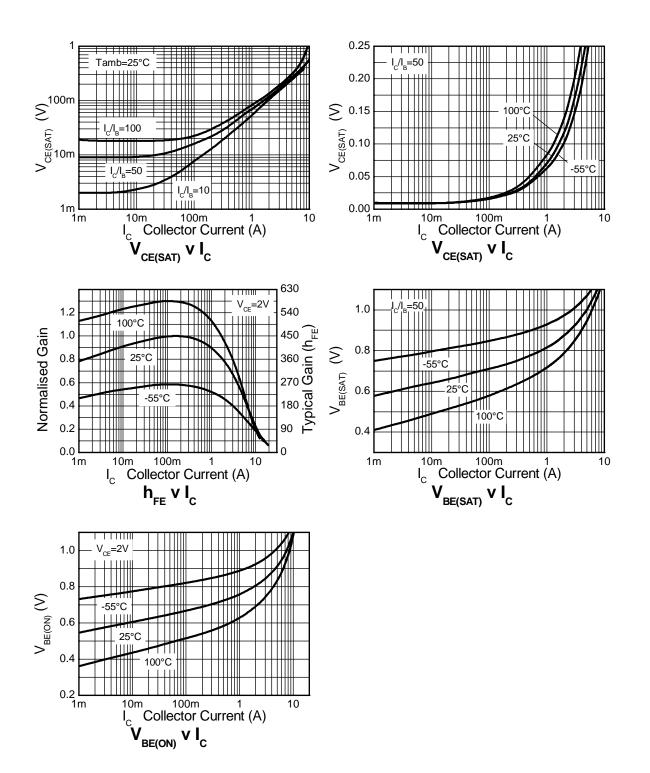
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	40	70	-	V	I <sub>C</sub> = 100μA
Collector-Emitter Breakdown Voltage (Note 12)	BV <sub>CEO</sub>	15	18	-	V	I <sub>C</sub> = 10mA
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	7	8.2	-	V	I <sub>E</sub> = 100μA
Collector Cutoff Current	I <sub>CBO</sub>	-	-	100	nA	$V_{CB} = 30V$
Emitter Cutoff Current	I <sub>EBO</sub>	-	-	100	. nA	$V_{EB} = 6V$
Collector Emitter Cutoff Current	ICES	-	-	100	nA	$V_{CE} = 12V$
Static Forward Current Transfer Ratio (Note 12)	hfe	200 300 200 150 -	415 450 320 240 80		-	$\begin{split} I_{C} &= 10 \text{mA}, \ V_{CE} = 2 \text{V} \\ I_{C} &= 200 \text{mA}, \ V_{CE} = 2 \text{V} \\ I_{C} &= 3 \text{A}, \ V_{CE} = 2 \text{V} \\ I_{C} &= 5 \text{A}, \ V_{CE} = 2 \text{V} \\ I_{C} &= 12 \text{A}, \ V_{CE} = 2 \text{V} \end{split}$
Collector-Emitter Saturation Voltage (Note 12)	V <sub>CE(sat)</sub>	-	8 70 165 240 200	14 100 200 310 -	mV	$\begin{split} & I_{C} = 0.1A, \ I_{B} = 10mA \\ & I_{C} = 1A, \ I_{B} = 10mA \\ & I_{C} = 3A, \ I_{B} = 50mA \\ & I_{C} = 4.5A, \ I_{B} = 50mA \\ & I_{C} = 4.5A, \ I_{B} = 100mA \end{split}$
Base-Emitter Turn-On Voltage (Note 12)	V <sub>BE(on)</sub>	-	0.88	0.96	V	$I_{C} = 4.5A, V_{CE} = 2V$
Base-Emitter Saturation Voltage (Note 12)	V <sub>BE(sat)</sub>	-	0.94	1.05	V	$I_{C} = 4.5A, I_{B} = 50mA$
Output Capacitance	Cobo	-	30	40	pF	V <sub>CB</sub> = 10V. f = 1MHz
Transition Frequency	f <sub>T</sub>	80	120	-	MHz	$V_{CE} = 10V, I_C = 50mA,$ f = 100MHz
Turn-on Time	t <sub>on</sub>	-	120	-	ns	$V_{CC} = 10V, I_{C} = 1A$
Turn-off Time	t <sub>off</sub>	-	160	-	ns	$I_{B1} = I_{B2} = 10 \text{mA}$

Notes: 12. Measured under pulsed conditions. Pulse width  $\leq$  300µs. Duty cycle  $\leq$  2%.

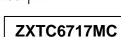


# ZXTC6717MC

# NPN – Typical Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)







#### Characteristic Symbol Min Max Unit **Test Condition** Тур $I_{\rm C} = -100 \mu A$ Collector-Base Breakdown Voltage -20 -35 **BV**CBO ٧ Collector-Emitter Breakdown Voltage (Note 12) -12 -25 V $I_{C} = -10 mA$ $\mathsf{BV}_{\mathsf{CEO}}$ \_ Emitter-Base Breakdown Voltage -7 -8.5 V $I_{E} = -100 \mu A$ **BV**<sub>EBO</sub> \_ Collector Cutoff Current -100 - $V_{CB} = -16V$ Ісво nA Emitter Cutoff Current \_ -100 nΑ $V_{EB} = -6V$ I<sub>EBO</sub> $V_{CES} = -10V$ Collector Emitter Cutoff Current -100 nA ICES $I_{C} = -10mA, V_{CE} = -2V$ 300 475 - $I_{C} = -100 \text{mA}, V_{CE} = -2 \text{V}$ 300 450 -Static Forward Current Transfer Ratio (Note 12) $I_C = -2.5A, V_{CE} = -2V$ h<sub>FE</sub> 180 275 -60 100 - $I_{C} = -8A, V_{CE} = -2V$ 70 45 $I_{C} = -10A, V_{CE} = -2V$ $I_{C} = -0.1A, I_{B} = -10mA$ -10 -17 - $I_{C} = -1A, I_{B} = -10mA$ -140 -100 Collector-Emitter Saturation Voltage (Note 12) V<sub>CE(sat)</sub> --100 -150 mV $I_{C} = -1.5A, I_{B} = -50mA$ -300 --195 $I_{\rm C} = -3A, I_{\rm B} = -50mA$ -240 -310 $I_{C} = -4A, I_{B} = -150mA$ Base-Emitter Turn-On Voltage (Note 12) --0.87 -0.96 V $I_{C} = -4A, V_{CE} = -2V$ V<sub>BE(on)</sub> Base-Emitter Saturation Voltage (Note 12) -0.97 -1.07 $I_{C} = -4A, I_{B} = -150mA$ V V<sub>BE(sat)</sub> -Output Capacitance 21 30 V<sub>CB</sub> = -10V. f = 1MHz pF $C_{\text{obo}}$ - $V_{CE} = -10V, I_C = -50mA,$ Transition Frequency 100 110 -MHz f<sub>T</sub> f = 100MHz70 Turn-on Time $V_{CC} = -6V, I_C = -2A$ ns ton -130 Turn-off Time $I_{B1} = I_{B2} = -50 \text{mA}$ toff -ns Notes: 12. Measured under pulsed conditions. Pulse width $\leq$ 300µs. Duty cycle $\leq$ 2%.

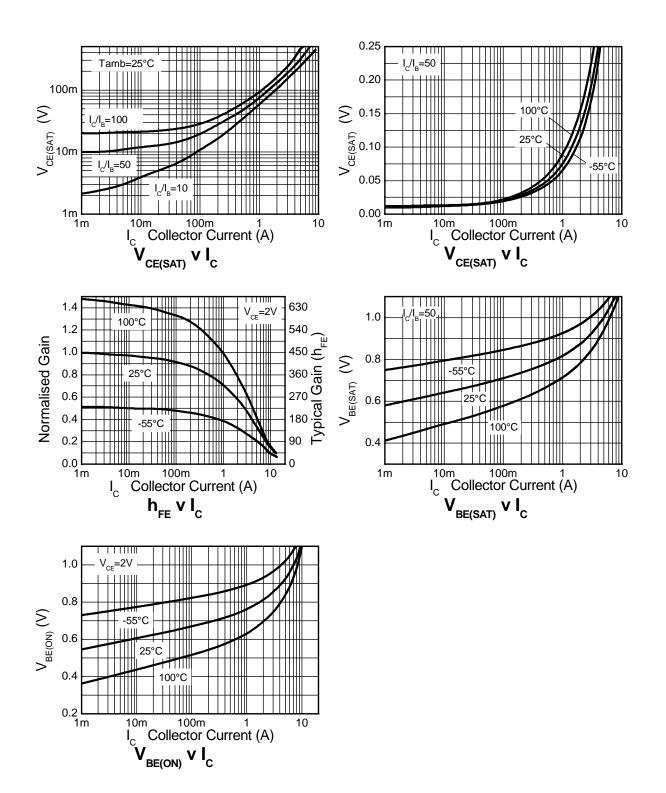
### PNP - Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

ZXTC6717MC Document number: DS31926 Rev. 4 - 2



# ZXTC6717MC

### PNP – Typical Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)



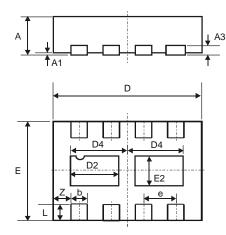




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### **Package Outline Dimensions**

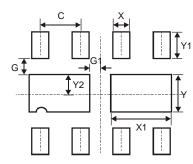
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



W-DFN3020-8						
Type B						
Dim	Min	Max	Тур			
Α	0.77	0.83	0.80			
A1	0	0.05	0.02			
A3	-	-	0.15			
b	0.25	0.35	0.30			
D	2.95	3.075	3.00			
D2	0.82	1.02	0.92			
D4	1.01	1.21	1.11			
e	-	-	0.65			
Е	1.95	2.075	2.00			
E2	0.43	0.63	0.53			
L	0.25	0.35	0.30			
Ζ	-	-	0.375			
All Dimensions in mm						

### **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)			
С	0.650			
G	0.285			
G1	0.090			
Х	0.400			
X1	1.120			
Y	0.730			
Y1	0.500			
Y2	0.365			



# ZXTC6717MC

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